

## Electronic Patent Application Fee Transmittal

Application Number:	10567733			
Filing Date:	10-Feb-2006			
Title of Invention:	Method for forming film, method for manufacturing semiconductor device, semiconductor device and substrate treatment system			
First Named Inventor/Applicant Name:	Kohei Kawamura			
Filer:	Marvin Jay Spivak/Yuriko Stankich			
Attorney Docket Number:	285995US26PCT			

Filed as Large Entity

### **U.S. National Stage under 35 USC 371 Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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**Basic Filing:**

**Pages:**

**Claims:**

**Miscellaneous-Filing:**

**Petition:**

**Patent-Appeals-and-Interference:**

**Post-Allowance-and-Post-Issuance:**

**Extension-of-Time:**

Extension - 3 months with \$0 paid	1253	1	1110	1110
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>1110</b>